

HSP

NOTES:

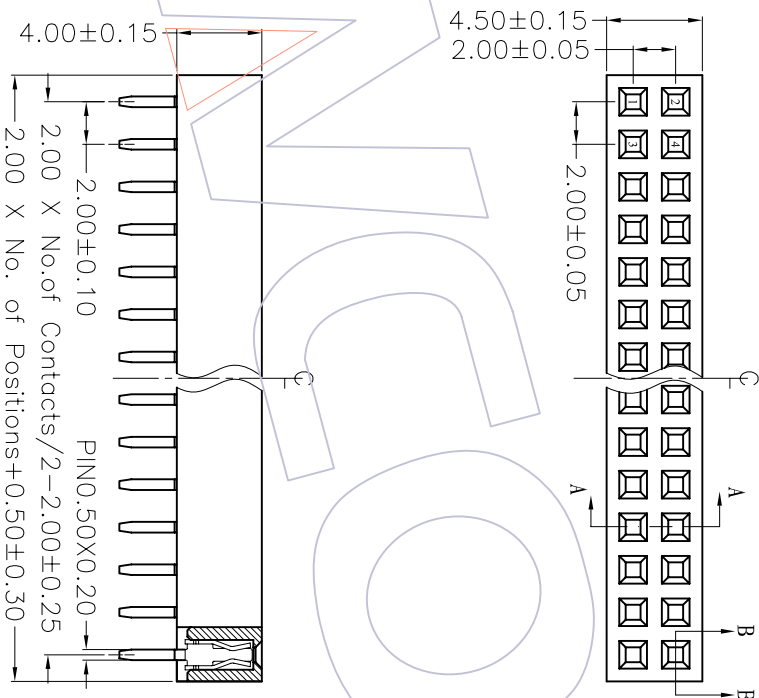
Current Rating: 2.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G, F UL94V-0

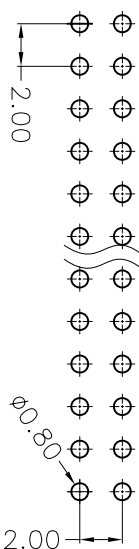
Ordering Information

2240 - 2 XX S XX CUNT 1

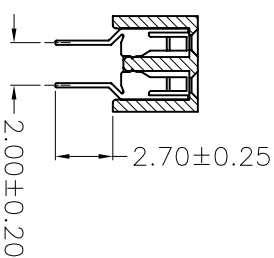
No. of Pins per ROW: 32-40PIN
 Contact Plating: G=Gold Flash, GI=3μ"Gold, GS=5μ"Gold, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold
 S0=Gold Flash/Tin, S1=3μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin
 Packing: T=Tube, P=Tube+CAP, R=Tray&Reel+CAP



SECTION B-B



Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE±0.05)



SECTION A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/28	NEW			XXX XXX XXX Angle DIM	Mei-Li 08.02.28	3:1 mm A4	2240-2XXSXXCUNT1	Φ12.00mm DIA. 180° H=4.00
1					±0.40 ±0.25 ±0.15 ±.3'				

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